# **MA2S374**

# Silicon epitaxial planar type

### For CATV tuner

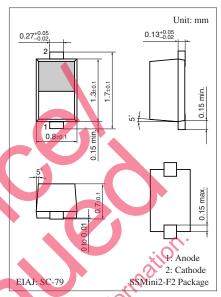
#### ■ Features

- Small series resistance r<sub>D</sub>
- SS-Mini type package, allowing downsizing of equipment and automatic insertion through the taping package

# ■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter	Symbol	Rating	Unit
Reverse voltage	$V_R$	34	V
Maximum peak reverse voltage *	$V_{RM}$	35	V
Junction temperature	T <sub>j</sub>	150	°C
Storage temperature	$T_{stg}$	-55 to +150	°C

Note) \*:  $R_L = 10 \text{ k}\Omega$ 



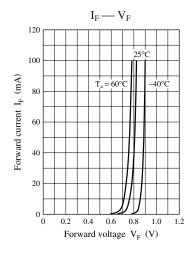
Marking Symbol:

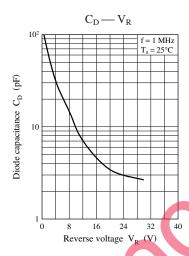
## ■ Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

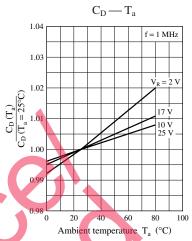
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Reverse current	$I_R$	$V_R = 30 \text{ V}$			10	nA
Diode capacitance	C <sub>D(0V)</sub> *1	$V_R = 0 \text{ V, f} = 1 \text{ MHz}$	87			pF
	$C_{D(2V)}$	$V_R = 2 V, f = 1 MHz$	44.00		50.79	
170	C <sub>D(25V)</sub>	$V_R = 25 \text{ V}, f = 1 \text{ MHz}$	2.60		3.03	
	C <sub>D(10V)</sub>	$V_R = 10 \text{ V, } f = 1 \text{ MHz}$	8.80		13.08	
	C <sub>D(17V)</sub>	$V_R = 17 \text{ V, f} = 1 \text{ MHz}$	3.70		5.04	
Capacitance ratio	C <sub>D(2V)</sub> /C <sub>D(25V)</sub>		15.0			_
Diode capacitance deviation	<b>⊘</b> ∆C	C <sub>D(2V)(10V)(17V)(25V)</sub>			2.0	%
Series resistance *2	$r_{\mathrm{D}}$	$C_D = 9 \text{ pF, f} = 470 \text{ MHz}$			0.9	Ω

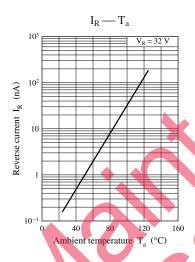
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.

- 2. Absolute frequency of input and output is 470 MHz.
- 3. \*1: Measurement at low signal level
  - \*2: Measuring instrument; YHP MODEL 4191A RF IMPEDANCE ANALYZER









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